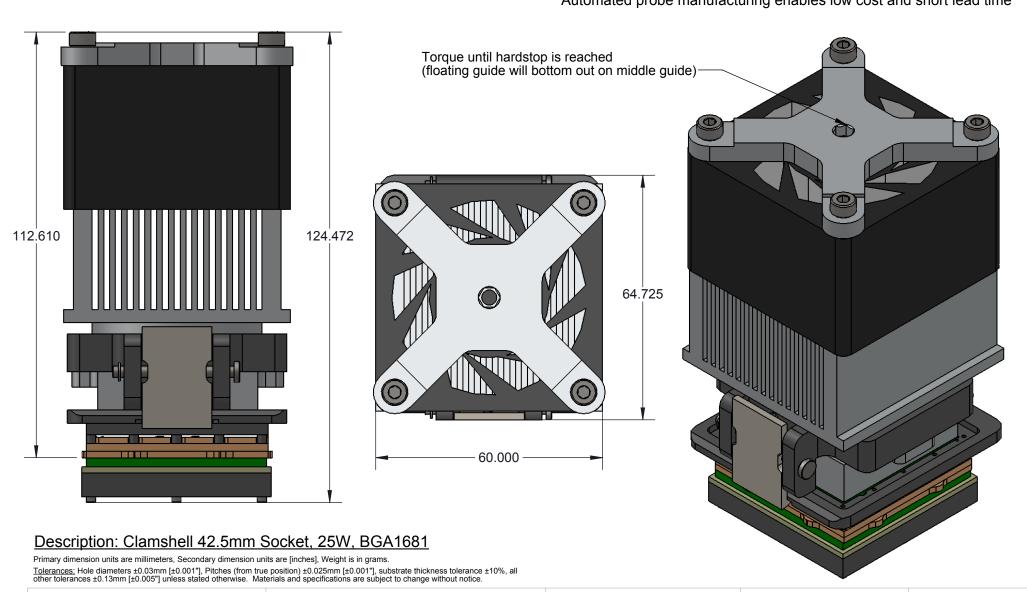
# CBT-BGA DIRECT MOUNT, SOLDERLESS SOCKET FOR BURN-IN AND TEST APPLICATIONS

#### **FEATURES**:

Wide temperature range (-55C to +180C)
High current capability (up to 4A)
Excellent signal integrity at high frequencies
Low and stable contact resistance for reliable production yield
Highly compliant to accommodate wide co-planarity variations
Automated probe manufacturing enables low cost and short lead time

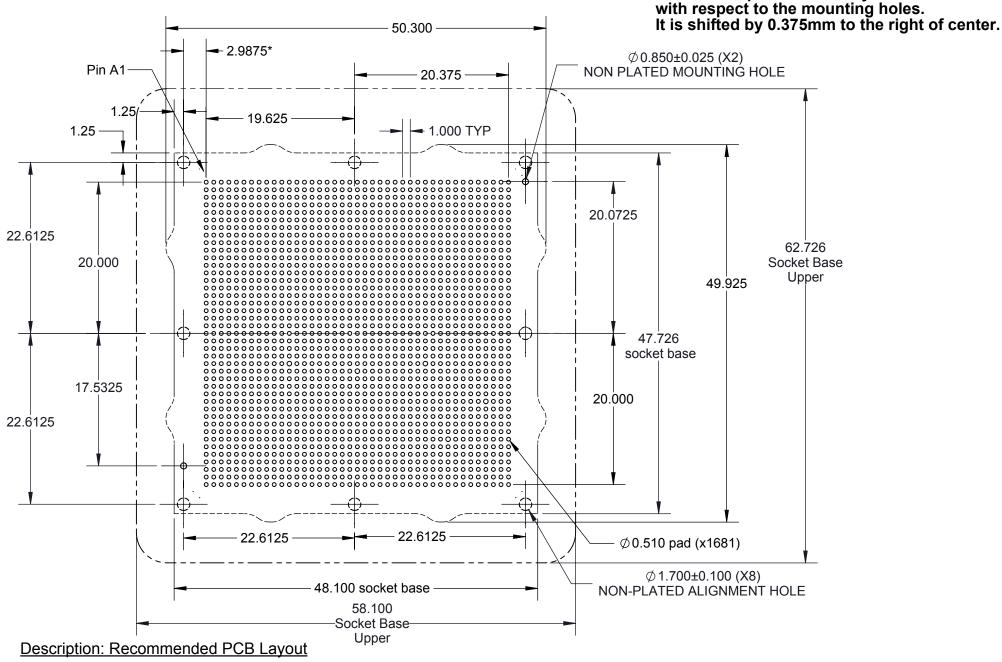


#### **CBT-BGA-6041 Drawing**

Ironwood Electronics, Inc.
Tele: (800) 404-0204
www.ironwoodelectronics.com

Material: N/A Finish: N/A Weight: 603.85

STATUS: Released	SHEET: 1 OF 5	REV. B
ENG: M.A. Fedde	DRAWN BY: M. Raske	SCALE: 1:1
FILE: CBT-BGA-6041 Dwg	DATE: 04/25/2014	



Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams

Tolerances: Hole diameters ±0.0254mm [±0.001"], Pitches (from true position) ±0.0762mm [±0.003"], substrate thickness tolerance ±10%, all other tolerances ±0.127mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

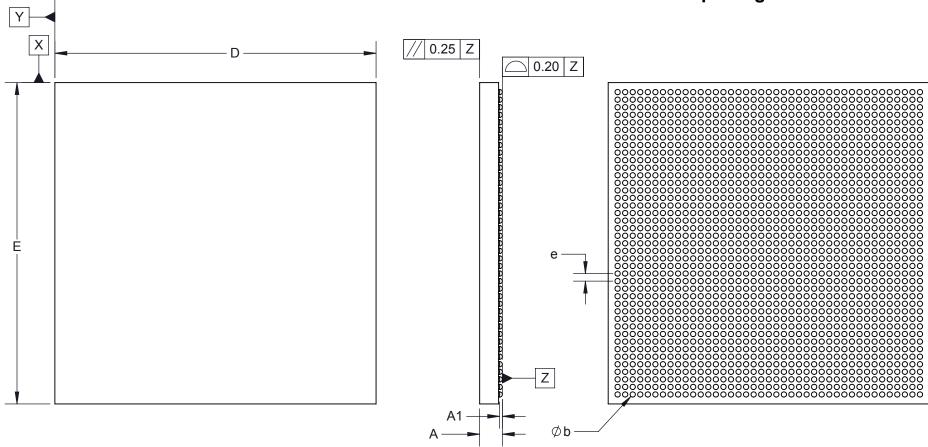
# CBT-BGA-6041 Drawing

Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com Material: N/A Finish: N/A Weight: 603.85

STATUS: Released	SHEET: 2 OF 5	REV. B
ENG: M.A. Fedde	DRAWN BY: M. Raske	SCALE: 2:1
FILE: CBT-BGA-6041 Dwg	DATE: 04/25/2014	

\*Note: BGA pattern is not symmetrical

## Ironwood package code: BGA1681A



- 1. Dimensions are in millimeters.
- 2. Interpret dimensions and tolerances per ASME Y14.5M-1994.
- 3. Dimension b is measured at the maximum solder ball diameter, parallel to datum plane Z.
- 4. Datum Z (seating plane) is defined by the spherical crowns of the solder balls.
- 5. Parallelism measurement shall exclude any effect of mark on top surface of package.

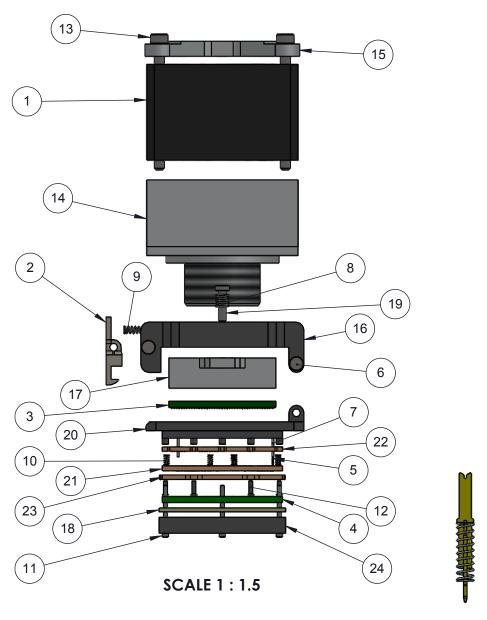
#### **Description: Compatible BGA**

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

other tolerances ±0.15mm [±0.005] unless stated otherwise. Materials and specifications are subject to change without notice.					
	CBT-BGA-6041 Drawing	Material: N/A	STATUS: Released	SHEET: 3 OF 5	REV. B
	Ironwood Electronics, Inc. Tele: (800) 404-0204	Finish: N/A Weight: 603.85	ENG: M.A. Fedde	DRAWN BY: M. Raske	SCALE: 2:1
₩.	www.ironwoodelectronics.com	Weight: 000.00	FILE: CBT-BGA-6041 Dwg	DATE: 04/25/2014	

DIM	Minimum	Maximum
Α	3.79	4.11
A1	0.40	0.60
b	0.55	0.65
D	42.50 BSC 42.50 BSC	
E		
е	1.00 BSC	
ARRAY	41x41	
PIN COUN	T 1681	



SCALE 6:1 PIN DETAIL

### **Description: Socket Assy**

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

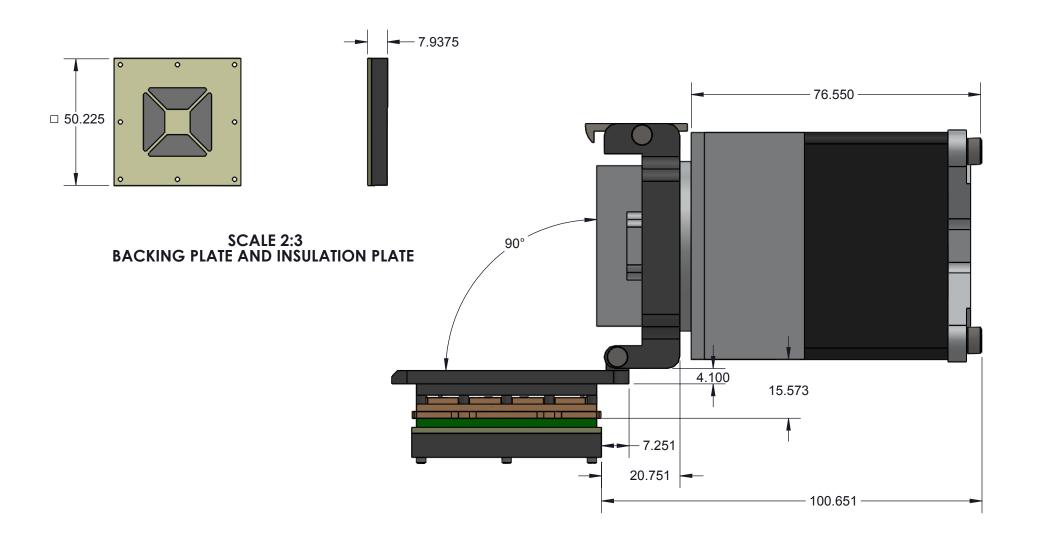
Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

# CBT-BGA-6041 Drawing

Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com Material: N/A Finish: N/A Weight: 603.85

ITEM NO.	DESCRIPTION	Material
1	Fan 60mmx60mmx38mm, 12V, 2.157 m3/min	Plastic (UL 94V-0)
2	Latch	7075-T6 Aluminum Alloy
3	BGA1681 ,1mm Pitch	FR4
4	Target PCB	FR4
5	Pogo Pin, 1mm Pitch SBT BGA pin	
6	Hinge Pin and Snap Ring, 3mm OD, 30mm long, 1045 Stl, Blk Oxide	AISI 1045 Steel, cold drawn
7	Dowel Pin, 1/32" x 3/8", SS	Chrome Stainless Steel
8	Spring Clamshell lid assembly	Steel Music Wire
9	Precision Compression Spring, Zinc-Plated Music Wire, 1/2" Length, .12" OD, .016" Wire	Zinc Plated Music Wire
10	Floating Guide Spring	Alloy Steel (SS)
11 #0-80 X .75 LG, SOC HD CAP SCREW, ALLOY STL, BLK OXIDE		Alloy Steel
12	#0-80, 90 deg., head pin guide screw, Peek material 5.5715mm overall Length	PEEK unfilled
13	Socket Head Cap Screw, M4 x 50mm	Stainless Steel (18-8)
14	Heatsink compression Screw	7075-T6 Alumium Alloy
15	Torquing bracket	7075-T6 Alumium Alloy
16	Clam Shell	7075-T6 Aluminum Alloy
17	Compression Plate	7075-T6 Aluminum Alloy
18	Insulation Plate, 50.225 X 50.225	FR4
19	Screw, M3 x 12mm, Low Head Cap, SS	18-8 Stainless Steel
20	Socket Base	7075-T6 Aluminum Alloy
21	Middle Guide BGA1681	Semitron MDS 100
22	Floating Guide 42.5mm, BGA1681	Semitron MDS 100
23	Bottom Guide BGA1681	Semitron MDS 100
24	Backing Plate	7075-T6 Aluminum Alloy

STATUS: Released	SHEET: 4 OF 5	REV. B
ENG: M.A. Fedde	DRAWN BY: M. Raske	SCALE: 1:1.5
FILE: CBT-BGA-6041 Dwg	DATE: 04/25/2014	



### **Description: Insulation Plate, Clearances**

Primary dimension units are millimeters, Secondary dimension units are [inches], Weight is in grams.

Tolerances: Hole diameters ±0.03mm [±0.001"], Pitches (from true position) ±0.025mm [±0.001"], substrate thickness tolerance ±10%, all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

Rev	Date	Initials	Description
A 04/25		MR	Original
В	04/02/15		Updated layout page to show added material bump out to pin nest assembly screw holes.

CBT	-BG	A-6	041	Draw	/ing



Ironwood Electronics, Inc. Tele: (800) 404-0204 www.ironwoodelectronics.com Material: N/A Finish: N/A Weight: 603.85

STATUS: Released	SHEET: 5 OF 5	REV. B
ENG: M.A. Fedde	DRAWN BY: M. Raske	SCALE: 1:1
FILE: CBT-BGA-6041 Dwg	DATE: 04/25/2014	